













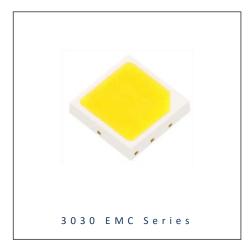




- ► EMC 2-PIN SMD
- ▶ 3030 0.66t
- ► Cool White (6500K)

N0W61S98





3030 EMC Series





FEATURES:

Package: Top View EMC White Package

Forward Current: 120mA Forward Voltage (typ.): 6.0V

Luminous Flux (typ.): 122lm@120mA

Colour: Cool White

Colour Temperature (CCT): 6500K

Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+105°C Storage Temperature: -40~+105°C

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 8mm tape with max.5000/reel, ø178mm (7")

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- Commercial Lighting
- **Indoor Lighting**
- Backlight for LCD



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	IF	240	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	Ipf	300	mA
Power Dissipation	P _D	1536	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	120	°C
Thermal Resistance (Junction to Solder Point)	R _{THJS}	12	°C/W
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	Tsol	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

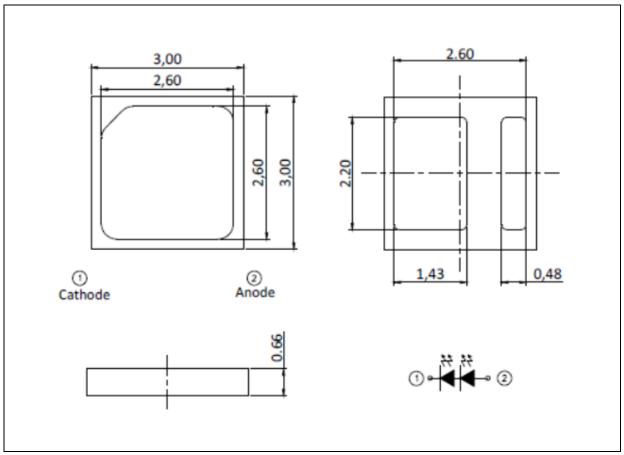
Parameter Symbol			Values		Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V _F	5.8	6.0	6.6	V	I _F =120mA
Luminous Flux	Ф۷	115	122		lm	I _F =120mA
Luminous Efficiency			169		lm/W	I _F =120mA
Chromaticity	Х		0.3187			I _F =120mA
Coordinates	Υ		0.3387			
Colour Temperature	ССТ		6500		К	I _F =120mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =120mA

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, CRI ±2



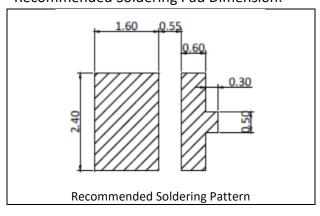
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 120mA):

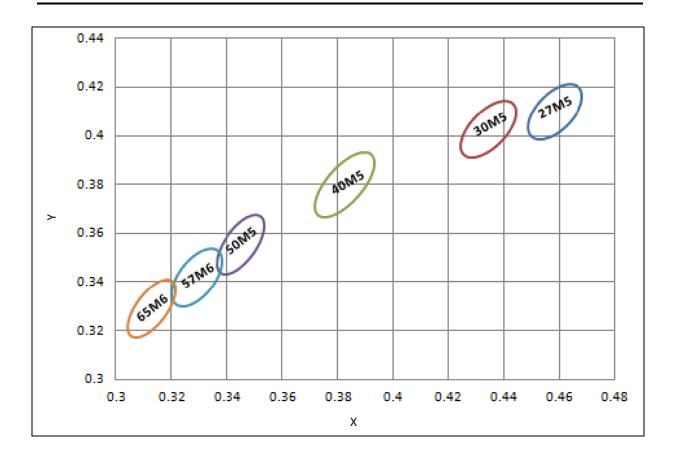
Code	Min.	Max.	Unit
A4	5.8	6.0	
B4	6.0	6.2	V
C4	6.2	6.3	V
D4	6.3	6.6	

Luminous Flux Classifications (I_F = 120mA):

Code	Min.	Max.	Unit
5H	115	120	
5J	120	125	
5K	125	130	lm
5L	130	135	
5M	135	140	



CIE CHROMATICITY DIAGRAM:



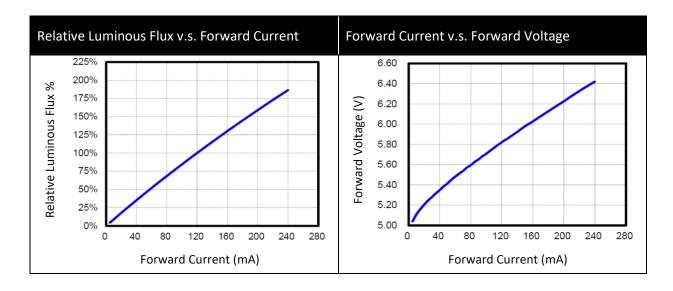
Chromaticity Coordinates Classifications (I_F = 120mA):

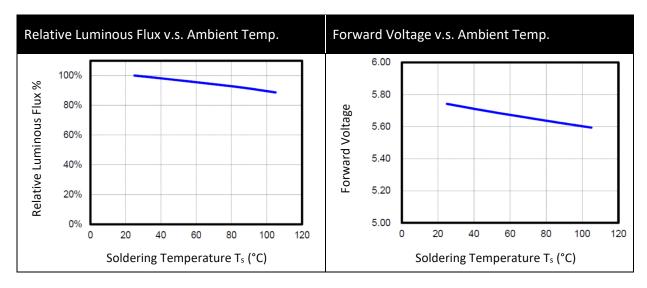
Ra80: *B	Code	Centre		Radius		Angle
3 *BJ *BK		Х	Υ	а	b	Ф
*BB *BB 6 *BB *BB 7 *BM *BL 7	1B-3STEP	0.2107	0.3387	0.006690	0.002850	58.34
	1B-5STEP	0.3187		0.011150	0.004750	

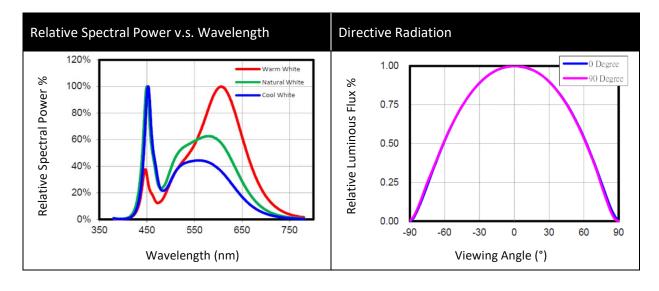
	1	1	2	2	3	3	2	4
	Х	Υ	Х	Y	Х	Υ	Х	Υ
1	0.3124	0.3210	0.3084	0.3401	0.3261	0.3578	0.3277	0.3358



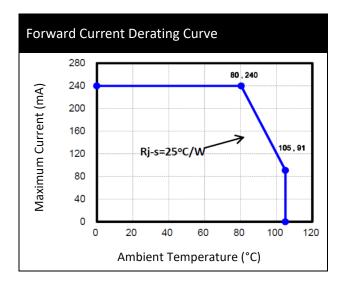
ELECTRO-OPTICAL CHARACTERISTICS:







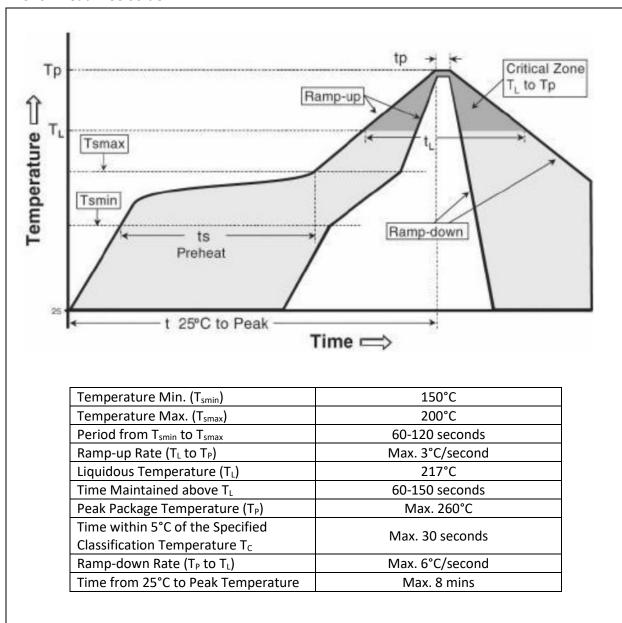






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



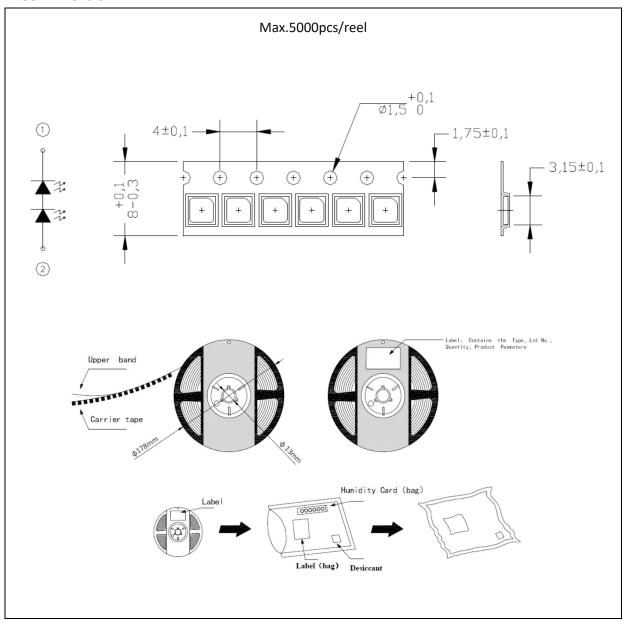
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

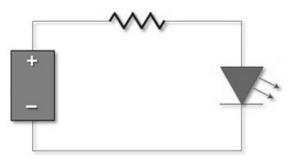
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	13/07/2022	Datasheet set-up.